

FIG. 1

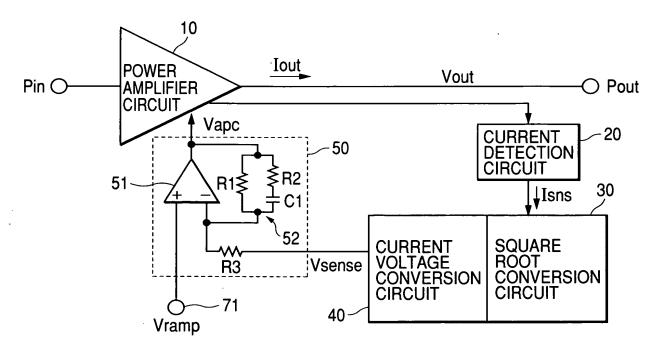
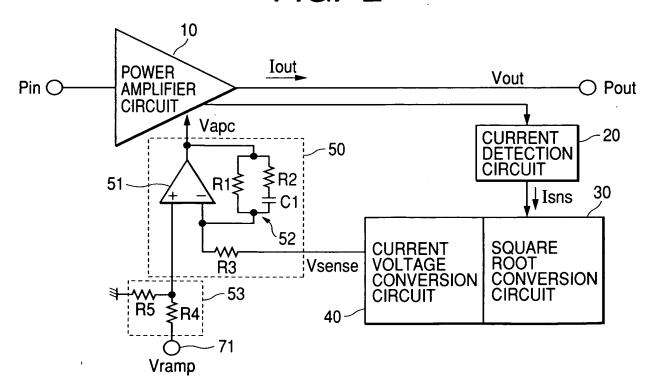
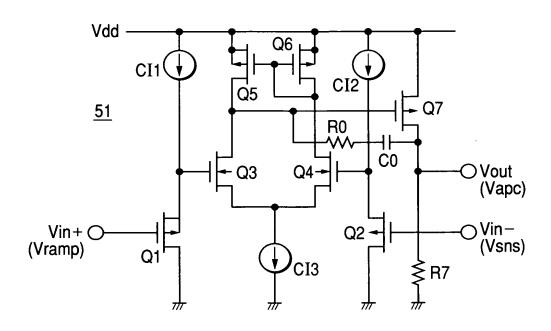


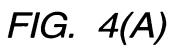
FIG. 2



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FIG. 3











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FIG. 5(A)

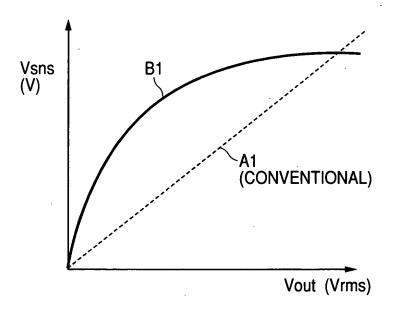
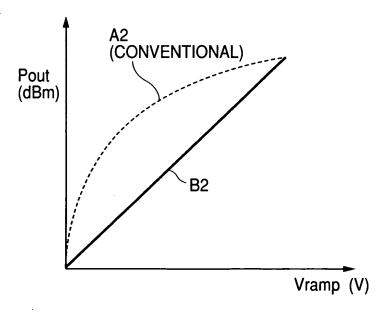


FIG. 5(B)



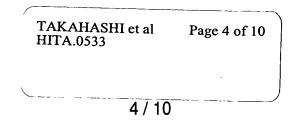


FIG. 6(A)

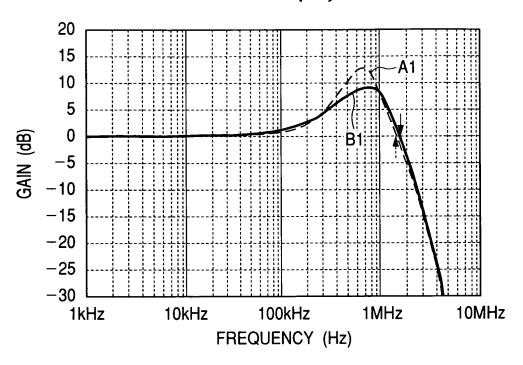
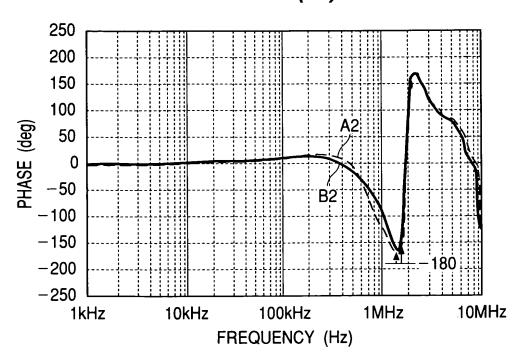


FIG. 6(B)



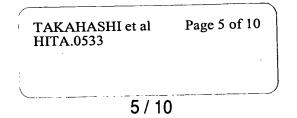


FIG. 7(A)

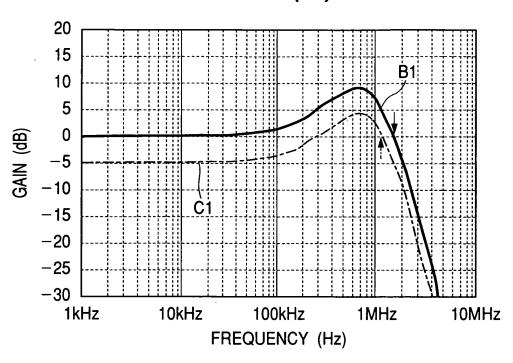
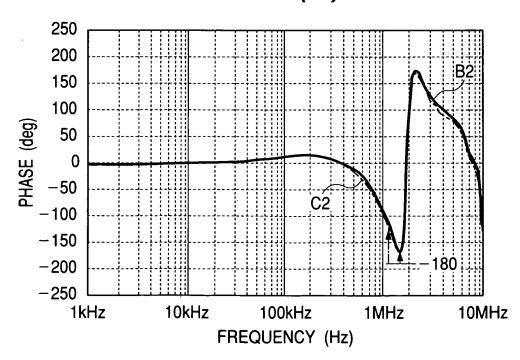


FIG. 7(B)



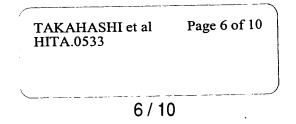


FIG. 8(A)

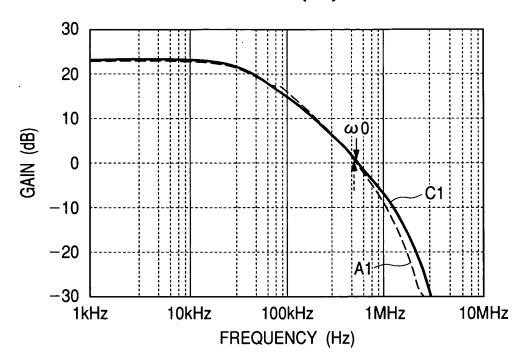
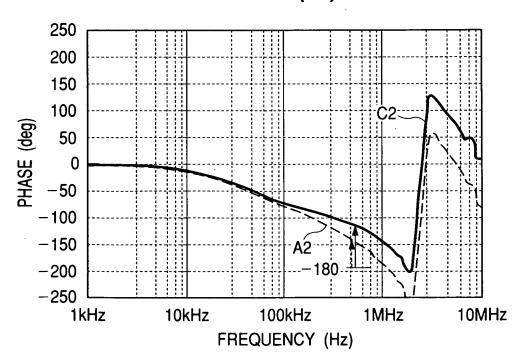
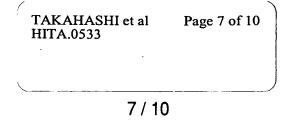
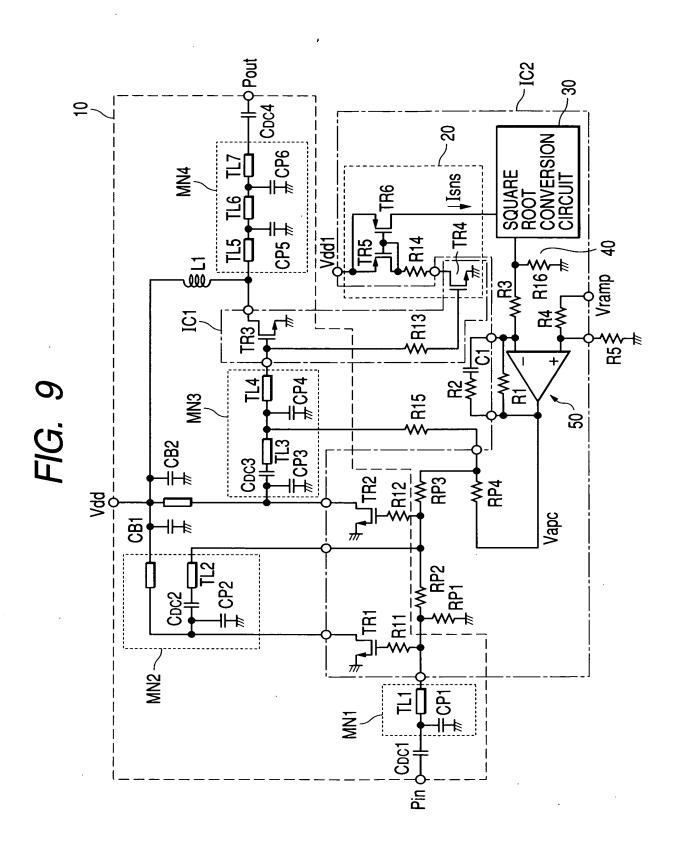
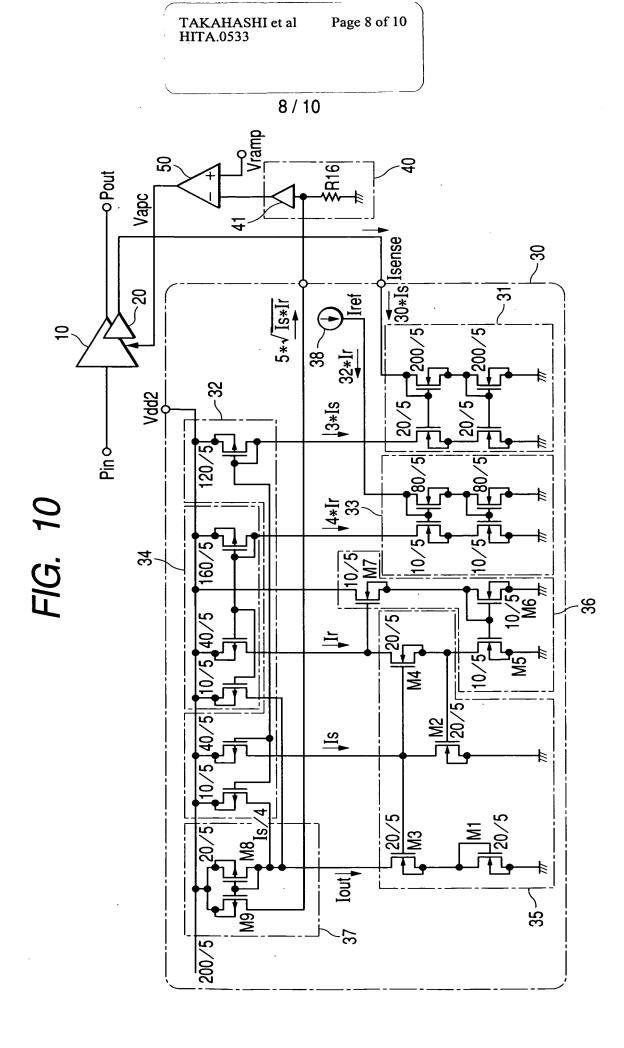


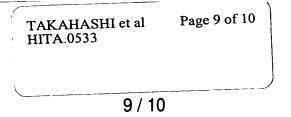
FIG. 8(B)











_ ANT 100 -200 120b 410b 120a 띰 LPF SAW SAW FIG. 11 Vramp, Mode 200 Pout GSM DCS CPU GSM GSM A 210a DAC RF IC BASEBAND IC 300 O

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FIG. 12

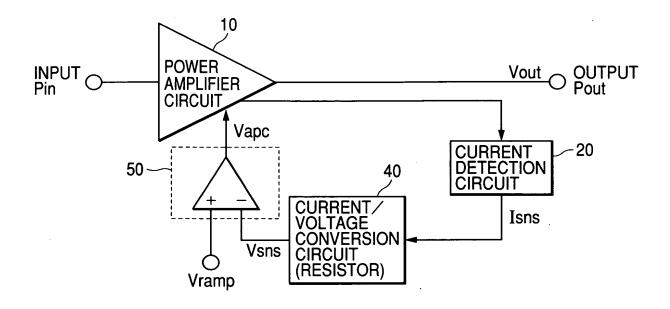


FIG. 13

